# PMZ1200UPE

## 30 V, P-channel Trench MOSFET

25 March 2015 Product data sheet

## 1. General description

P-channel enhancement mode Field-Effect Transistor (FET) in a leadless ultra small DFN1006-3 (SOT883) Surface-Mounted Device (SMD) plastic package using Trench MOSFET technology.

## 2. Features and benefits

- Trench MOSFET technology
- Low threshold voltage
- Very fast switching
- ElectroStatic Discharge (ESD) protection > 2 kV HBM
- Leadless ultra small SMD package: 1.0 x 0.6 x 0.48 mm

## 3. Applications

- Relay driver
- High-speed line driver
- High-side loadswitch
- Switching circuits

## 4. Quick reference data

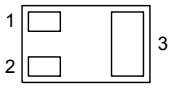
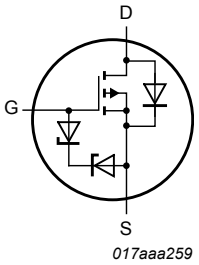
**Table 1. Quick reference data**

| Symbol | Parameter | Conditions | | Min | Typ | Max | Unit |
|---|---|---|---|---|---|---|---|
| $V_{DS}$ | drain-source voltage | $T_j$ = 25 °C | | - | - | -30 | V |
| $V_{GS}$ | gate-source voltage | | | -8 | - | 8 | V |
| $I_D$ | drain current | $V_{GS}$ = -4.5 V; $T_{amb}$ = 25 °C | [1] | - | - | -410 | mA |
| **Static characteristics** | | | | | | | |
| $R_{DSon}$ | drain-source on-state resistance | $V_{GS}$ = -4.5 V; $I_D$ = -410 mA; $T_j$ = 25 °C | | - | 1.2 | 1.4 | Ω |

[1] Device mounted on an FR4 Printed-Circuit Board (PCB), single-sided copper, tin-plated, mounting pad for drain 1 $cm^2$.

## 5. Pinning information

**Table 2. Pinning information**

| Pin | Symbol | Description | Simplified outline | Graphic symbol |
|---|---|---|---|---|
| 1 | G | gate |  Transparent top view **DFN1006-3 (SOT883)** |  |
| 2 | S | source | | |
| 3 | D | drain | | |

## 6. Ordering information

**Table 3. Ordering information**

| Type number | Package | | |
|---|---|---|---|
| | Name | Description | Version |
| PMZ1200UPE | DFN1006-3 | DFN1006-3: leadless ultra small plastic package; 3 solder lands | SOT883 |

## 7. Marking

**Table 4. Marking codes**

| Type number | Marking code |
|---|---|
| PMZ1200UPE | ZL |

# 8. Limiting values

**Table 5. Limiting values**

*In accordance with the Absolute Maximum Rating System (IEC 60134).*

| Symbol | Parameter | Conditions | | Min | Max | Unit |
|---|---|---|---|---|---|---|
| $V_{DS}$ | drain-source voltage | $T_j$ = 25 °C | | - | -30 | V |
| $V_{GS}$ | gate-source voltage | | | -8 | 8 | V |
| $I_D$ | drain current | $V_{GS}$ = -4.5 V; $T_{amb}$ = 25 °C | [1] | - | -410 | mA |
| | | $V_{GS}$ = -4.5 V; $T_{amb}$ = 100 °C | [1] | - | -260 | mA |
| $I_{DM}$ | peak drain current | $T_{amb}$ = 25 °C; single pulse; $t_p \leq 10$ µs | | - | -1.7 | A |
| $P_{tot}$ | total power dissipation | $T_{amb}$ = 25 °C | [2] | - | 310 | mW |
| | | | [1] | - | 400 | mW |
| | | $T_{sp}$ = 25 °C | | - | 1670 | mW |
| $T_j$ | junction temperature | | | -55 | 150 | °C |
| $T_{amb}$ | ambient temperature | | | -55 | 150 | °C |
| $T_{stg}$ | storage temperature | | | -65 | 150 | °C |
| **Source-drain diode** | | | | | | |
| $I_S$ | source current | $T_{amb}$ = 25 °C | [1] | - | -410 | mA |

[1] Device mounted on an FR4 Printed-Circuit Board (PCB), single-sided copper, tin-plated, mounting pad for drain 1 $cm^2$.

[2] Device mounted on an FR4 PCB, single-sided copper, tin-plated and standard footprint.

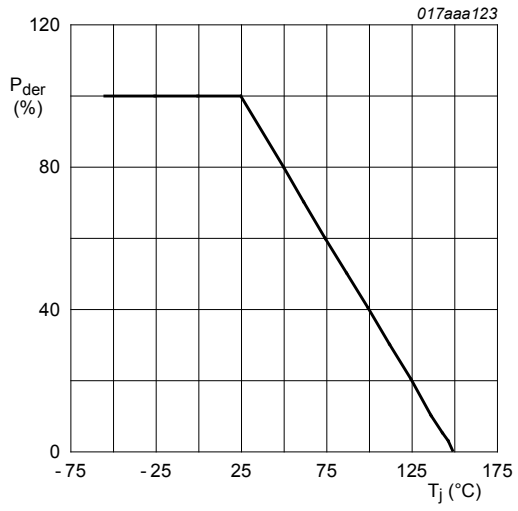



**Fig. 1. Normalized total power dissipation as a function of junction temperature**

$$P_{der} = \frac{P_{tot}}{P_{tot(25°C)}} \times 100\ \%$$

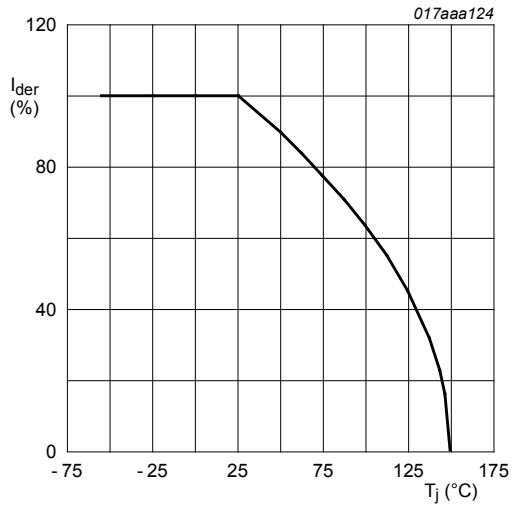



**Fig. 2. Normalized continuous drain current as a function of junction temperature**

$$I_{der} = \frac{I_D}{I_{D(25°C)}} \times 100\ \%$$

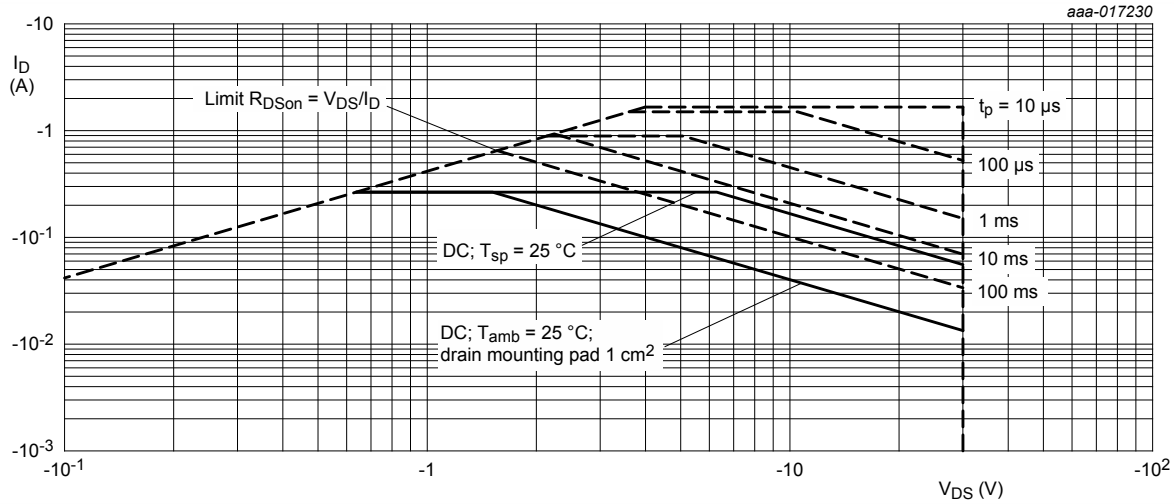



**Fig. 3. Safe operating area; junction to ambient; continuous and peak drain currents as a function of drain-source voltage**

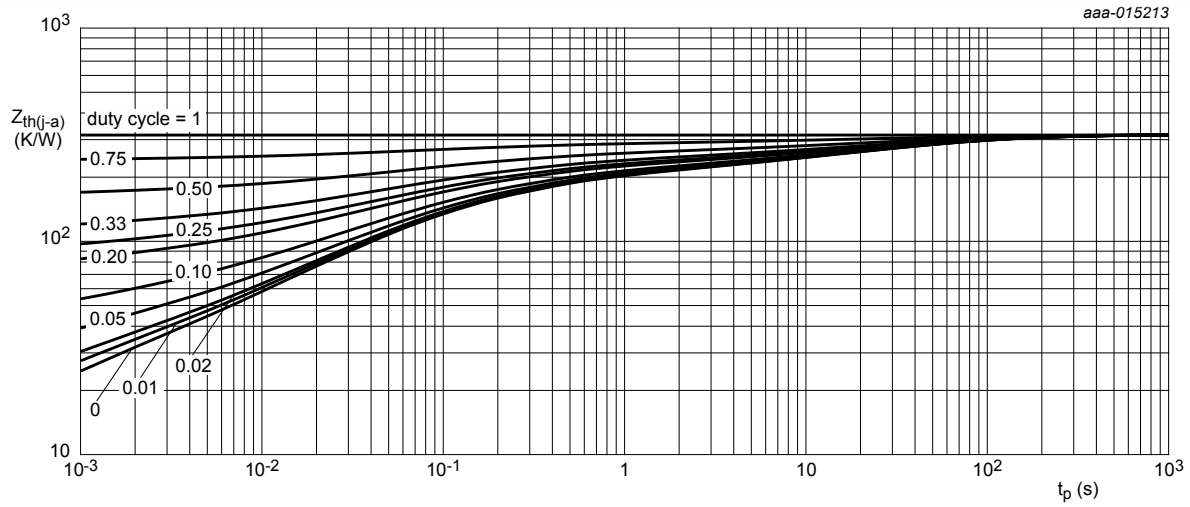
# 9. Thermal characteristics

**Table 6. Thermal characteristics**

| Symbol | Parameter | Conditions | | Min | Typ | Max | Unit |
|---|---|---|---|---|---|---|---|
| $R_{th(j-a)}$ | thermal resistance from junction to ambient | in free air | [1] | - | 350 | 405 | K/W |
| | | | [2] | - | 270 | 310 | K/W |
| $R_{th(j-sp)}$ | thermal resistance from junction to solder point | | | - | 65 | 75 | K/W |

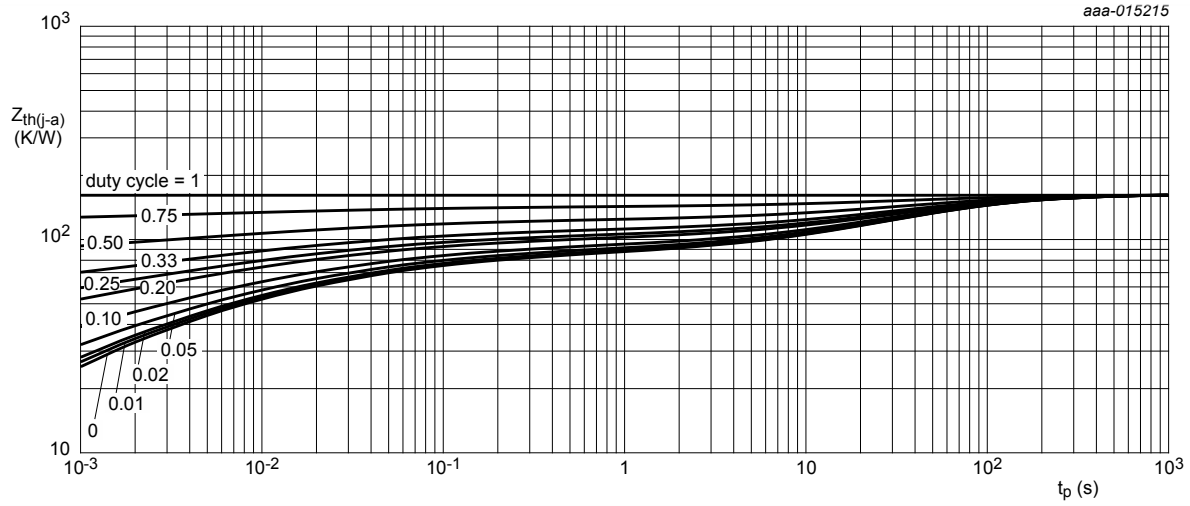
[1] Device mounted on an FR4 PCB, single-sided copper, tin-plated and standard footprint.

[2] Device mounted on an FR4 PCB, single-sided copper, tin-plated, mounting pad for drain 1 $cm^2$.




FR4 PCB, standard footprint

**Fig. 4. Transient thermal impedance from junction to ambient as a function of pulse duration; typical values**



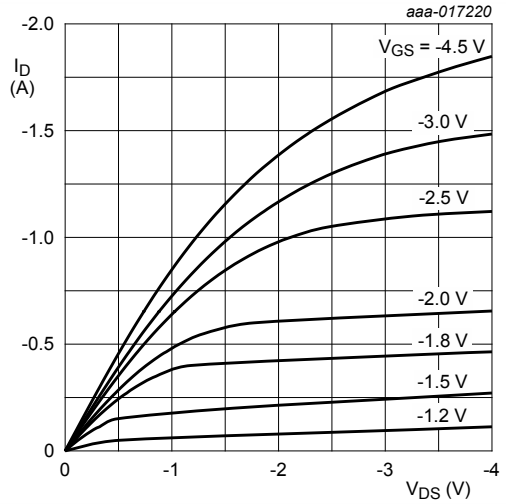

FR4 PCB, mounting pad for drain 1 $cm^2$

**Fig. 5. Transient thermal impedance from junction to ambient as a function of pulse duration; typical values**

# 10. Characteristics

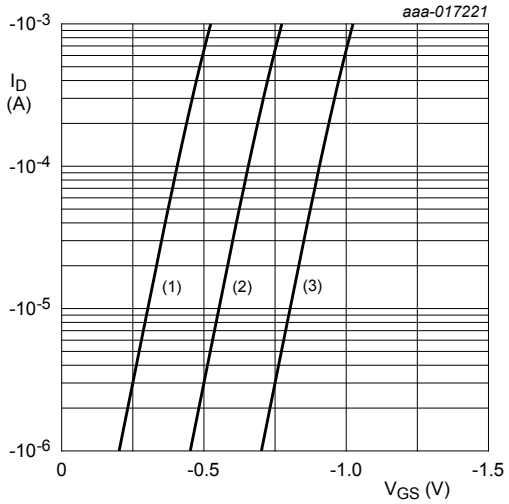
**Table 7. Characteristics**

| Symbol | Parameter | Conditions | | Min | Typ | Max | Unit |
|---|---|---|---|---|---|---|---|
| **Static characteristics** | | | | | | | |
| $V_{(BR)DSS}$ | drain-source breakdown voltage | $I_D$ = -250 µA; $V_{GS}$ = 0 V; $T_j$ = 25 °C | | -30 | - | - | V |
| $V_{GSth}$ | gate-source threshold voltage | $I_D$ = -250 µA; $V_{DS}$ = $V_{GS}$; $T_j$ = 25 °C | | -0.45 | -0.7 | -0.95 | V |
| $I_{DSS}$ | drain leakage current | $V_{DS}$ = -30 V; $V_{GS}$ = 0 V; $T_j$ = 25 °C | | - | - | -1 | µA |
| $I_{GSS}$ | gate leakage current | $V_{GS}$ = 8 V; $V_{DS}$ = 0 V; $T_j$ = 25 °C | | - | - | 5 | µA |
| | | $V_{GS}$ = -8 V; $V_{DS}$ = 0 V; $T_j$ = 25 °C | | - | - | -5 | µA |
| | | $V_{GS}$ = 4.5 V; $V_{DS}$ = 0 V; $T_j$ = 25 °C | | - | - | 1 | µA |
| | | $V_{GS}$ = -4.5 V; $V_{DS}$ = 0 V; $T_j$ = 25 °C | | - | - | -1 | µA |
| | | $V_{GS}$ = 2.5 V; $V_{DS}$ = 0 V; $T_j$ = 25 °C | | - | - | 100 | nA |
| | | $V_{GS}$ = -2.5 V; $V_{DS}$ = 0 V; $T_j$ = 25 °C | | - | - | -100 | nA |
| $R_{DSon}$ | drain-source on-state resistance | $V_{GS}$ = -4.5 V; $I_D$ = -410 mA; $T_j$ = 25 °C | | - | 1.2 | 1.4 | Ω |
| | | $V_{GS}$ = -4.5 V; $I_D$ = -410 mA; $T_j$ = 150 °C | | - | 2 | 2.4 | Ω |
| | | $V_{GS}$ = -2.5 V; $I_D$ = -320 mA; $T_j$ = 25 °C | | - | 1.7 | 2.3 | Ω |
| | | $V_{GS}$ = -1.8 V; $I_D$ = -80 mA; $T_j$ = 25 °C | | - | 2.1 | 3.1 | Ω |
| | | $V_{GS}$ = -1.5 V; $I_D$ = -10 mA; $T_j$ = 25 °C | | - | 3 | 5.1 | Ω |
| $g_{fs}$ | forward transconductance | $V_{DS}$ = -10 V; $I_D$ = -410 mA; $T_j$ = 25 °C | | - | 820 | - | mS |
| **Dynamic characteristics** | | | | | | | |
| $Q_{G(tot)}$ | total gate charge | $V_{DS}$ = -15 V; $I_D$ = -410 mA; $V_{GS}$ = -4.5 V; $T_j$ = 25 °C | | - | 0.7 | 1.2 | nC |
| $Q_{GS}$ | gate-source charge | | | - | 0.2 | - | nC |
| $Q_{GD}$ | gate-drain charge | | | - | 0.2 | - | nC |
| $C_{iss}$ | input capacitance | $V_{DS}$ = -15 V; f = 1 MHz; $V_{GS}$ = 0 V; $T_j$ = 25 °C | | - | 43.2 | - | pF |
| $C_{oss}$ | output capacitance | | | - | 5.9 | - | pF |
| $C_{rss}$ | reverse transfer capacitance | | | - | 4.2 | - | pF |
| $t_{d(on)}$ | turn-on delay time | $V_{DS}$ = -15 V; $I_D$ = -410 mA; $V_{GS}$ = -4.5 V; $R_{G(ext)}$ = 6 Ω; $T_j$ = 25 °C | | - | 3 | - | ns |
| $t_r$ | rise time | | | - | 4 | - | ns |
| $t_{d(off)}$ | turn-off delay time | | | - | 14 | - | ns |
| $t_f$ | fall time | | | - | 5 | - | ns |
| **Source-drain diode** | | | | | | | |
| $V_{SD}$ | source-drain voltage | $I_S$ = -410 mA; $V_{GS}$ = 0 V; $T_j$ = 25 °C | | - | -0.95 | -1.2 | V |




$T_j$ = 25 °C

**Fig. 6. Output characteristics: drain current as a function of drain-source voltage; typical values**




$V_{DS}$ = -5 V

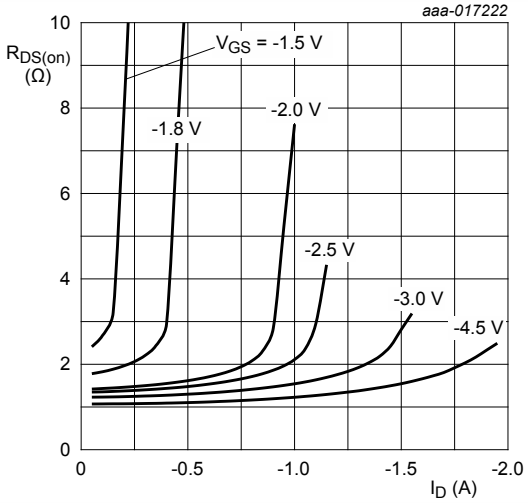
$T_j$ = 25 °C

(1) minimum values

(2) typical values

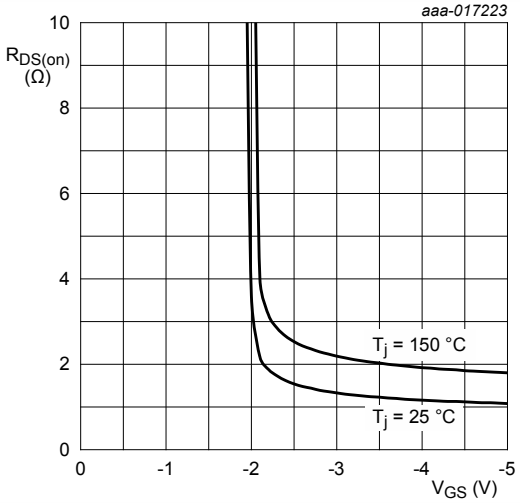
(3) maximum values

**Fig. 7. Sub-threshold drain current as a function of gate-source voltage**



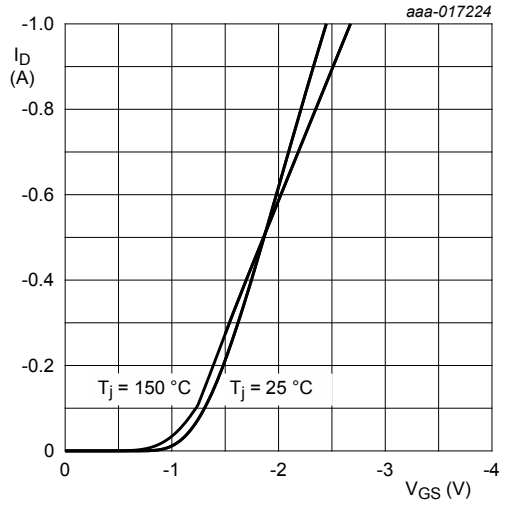

$T_j$ = 25 °C

**Fig. 8. Drain-source on-state resistance as a function of drain current; typical values**




$I_D$ = -0.4 A

**Fig. 9. Drain-source on-state resistance as a function of gate-source voltage; typical values**




$V_{DS} > I_D \times R_{DSon}$

**Fig. 10. Transfer characteristics: drain current as a function of gate-source voltage; typical values**

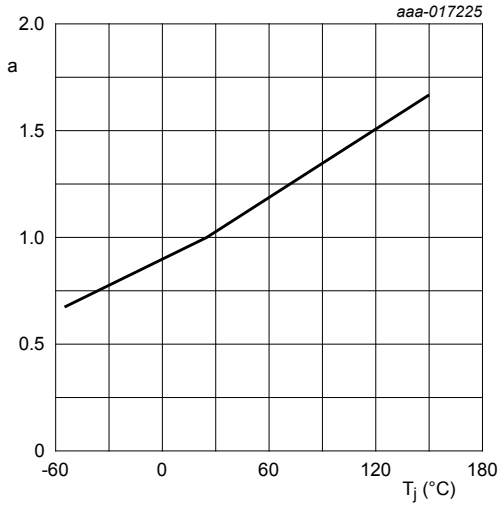
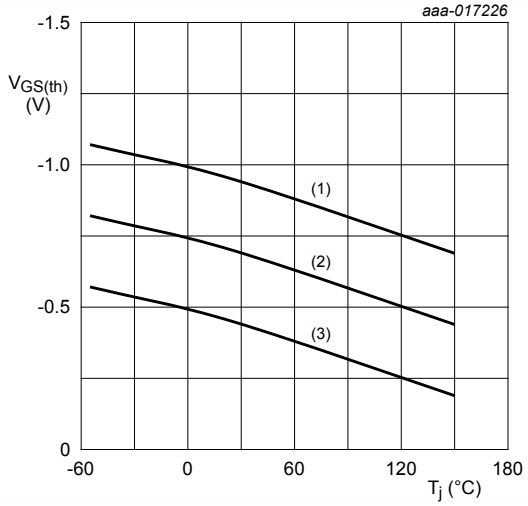



**Fig. 11. Normalized drain-source on-state resistance as a function of ambient temperature; typical values**

$$a = \frac{R_{DSon}}{R_{DSon(25°C)}}$$



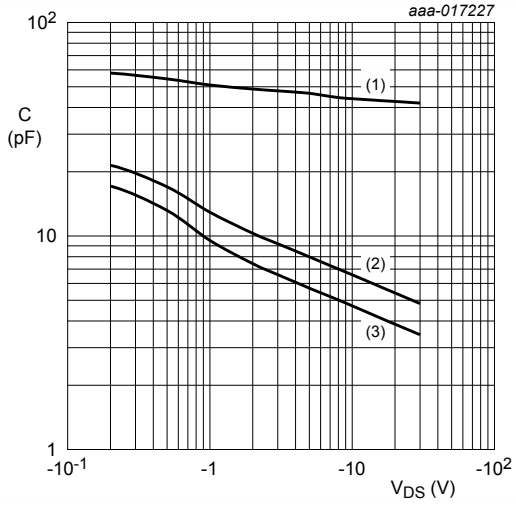

$I_D$ = -250 µA; $V_{DS} = V_{GS}$

(1) maximum values

(2) typical values

(3) minimum values

**Fig. 12. Gate-source threshold voltage as a function of junction temperature**



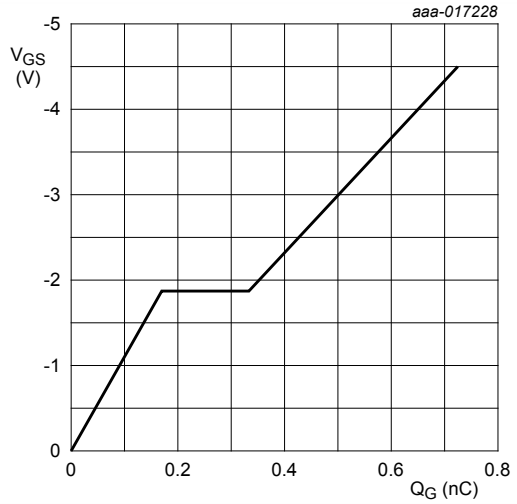

f = 1 MHz; $V_{GS}$ = 0 V

(1) $C_{iss}$

(2) $C_{oss}$

(3) $C_{rss}$

**Fig. 13. Input, output and reverse transfer capacitances as a function of drain-source voltage; typical values**




$V_{DS}$ = -15 V; $I_D$ = -410 mA $T_{amb}$ = 25 °C

**Fig. 14. Gate-source voltage as a function of gate charge; typical values**

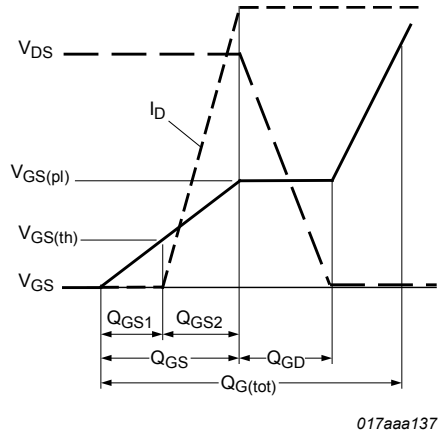
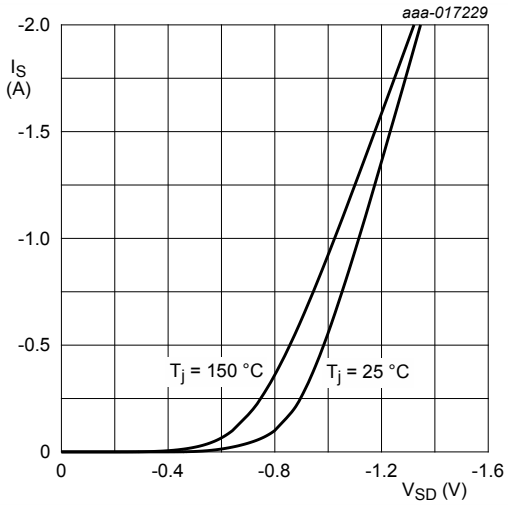



**Fig. 15. Gate charge waveform definitions**




$V_{GS}$ = 0 V

**Fig. 16. Source current as a function of source-drain voltage; typical values**

## 11. Test information

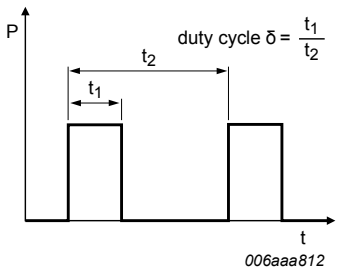
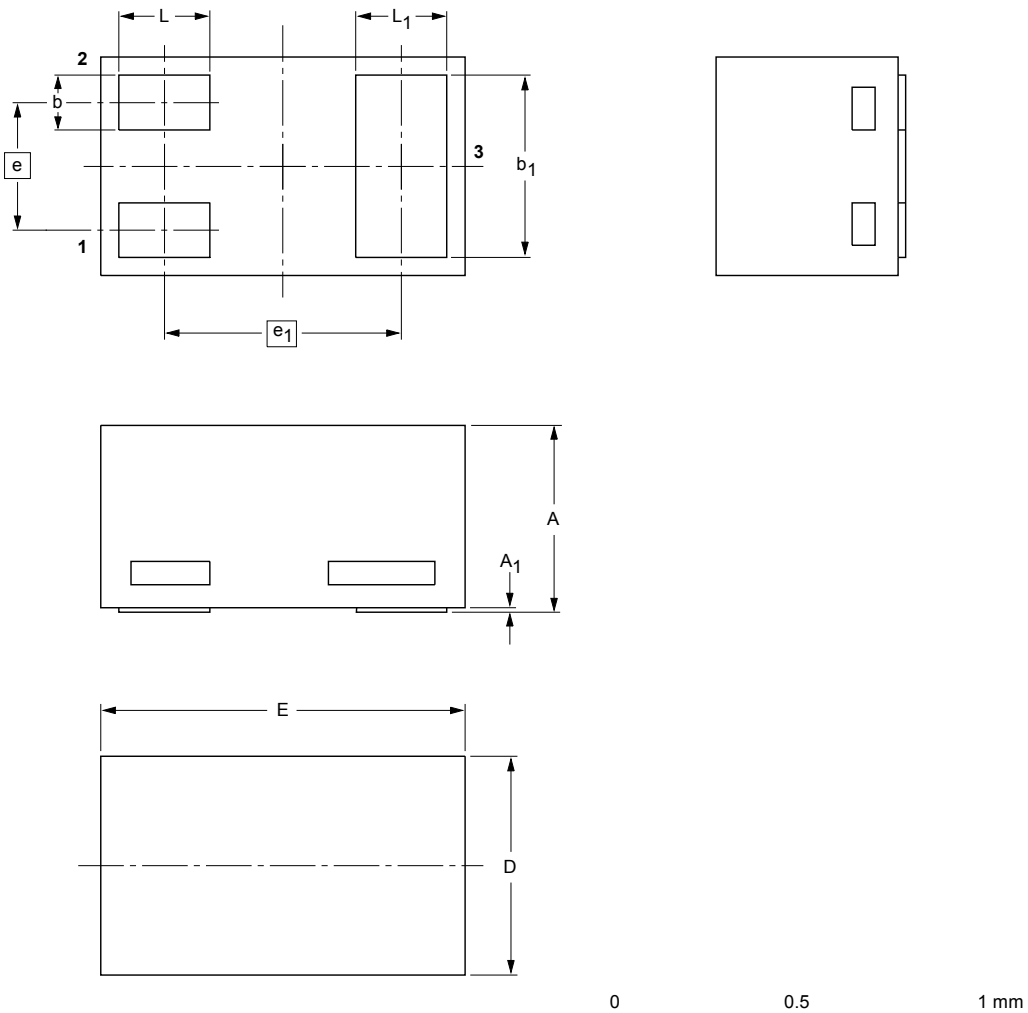



**Fig. 17. Duty cycle definition**

## 12. Package outline

**Leadless ultra small plastic package; 3 solder lands; body 1.0 x 0.6 x 0.5 mm** **SOT883**




**DIMENSIONS (mm are the original dimensions)**

| UNIT | A(1) | $A_1$ max. | b | $b_1$ | D | E | e | $e_1$ | L | $L_1$ |
|---|---|---|---|---|---|---|---|---|---|---|
| mm | 0.50<br>0.46 | 0.03 | 0.20<br>0.12 | 0.55<br>0.47 | 0.62<br>0.55 | 1.02<br>0.95 | 0.35 | 0.65 | 0.30<br>0.22 | 0.30<br>0.22 |

**Note**

1. Including plating thickness

| OUTLINE VERSION | REFERENCES | | | | EUROPEAN PROJECTION | ISSUE DATE |
|---|---|---|---|---|---|---|
| | IEC | JEDEC | JEITA | | | |
| SOT883 | | | SC-101 | | | ~~03-02-05~~<br>03-04-03 |

**Fig. 18. Package outline DFN1006-3 (SOT883)**

## 13. Soldering

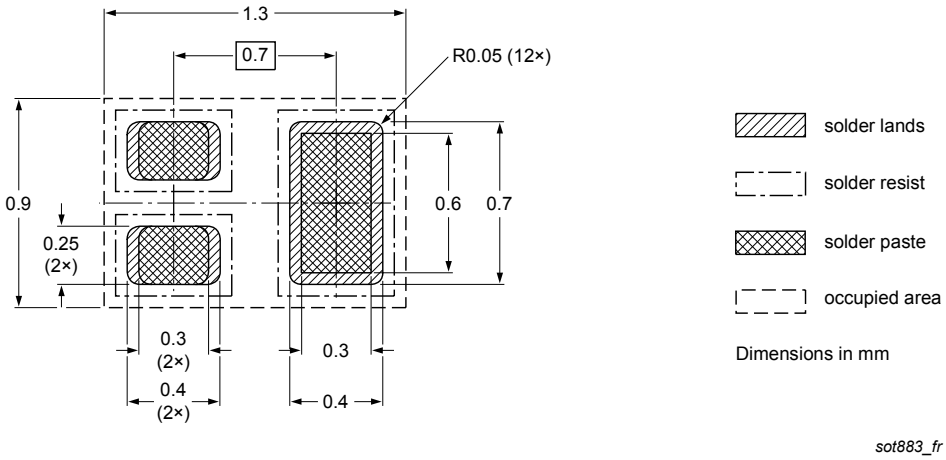



**Fig. 19. Reflow soldering footprint for DFN1006-3 (SOT883)**

# 14. Revision history

**Table 8. Revision history**

| Data sheet ID | Release date | Data sheet status | Change notice | Supersedes |
|---|---|---|---|---|
| PMZ1200UPE v.1 | 20150325 | Product data sheet | - | - |

# 15. Legal information

## 15.1 Data sheet status

| Document status [1][2] | Product status [3] | Definition |
|---|---|---|
| Objective [short] data sheet | Development | This document contains data from the objective specification for product development. |
| Preliminary [short] data sheet | Qualification | This document contains data from the preliminary specification. |
| Product [short] data sheet | Production | This document contains the product specification. |

[1] Please consult the most recently issued document before initiating or completing a design.
[2] The term 'short data sheet' is explained in section "Definitions".
[3] The product status of device(s) described in this document may have changed since this document was published and may differ in case of multiple devices. The latest product status information is available on the Internet at URL http://www.nexperia.com.

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**Date of release: 25 March 2015**